I.F.F. (Identification Friend or Foe) System

By

Eric Meyers (emeyer7)

Noah Prince (nprince2)

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TA: Braedon Salz

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Contents

1	Intr	oduction	1
	1.1	Statement of Purpose	1
	1.2	Objectives	1
	1.	2.1 Goals and Benefits	1
	1.	2.2 Functions and Features	1
2	Des	ign	2
	2.1	Block Diagrams and Descriptions	2
	2.	1.1 System Overview	2
	2.	.1.2 Friendly Interrogator Unit	2
	2.	.1.3 Friendly Target Unit	7
	2.2	Circuit Schematics	8
	2.	2.1 Friendly Interrogator Unit	8
	2.	2.2 Friendly Target Unit	10
	2.3	Functionality	11
	2.4	Software Flowcharts	11
	2.	4.1 System Flow	11
	2.	4.2 Friendly Interrogator Software Flow	11
	2.5	Numerical Analysis and Simulations/Plots	12
	2.	5.1 Calculations	12
	2.	5.2 Simulations/Plots	15
3	Req	quirements and Verification	15
	3.1	Tolerance Analysis	16
	3.2	Safety	16
	3.3	Ethical Issues	17
4	Cos	at and Schedule	19
	4.1	Cost Analysis	19
	4.2	Schedule	19
R	eforer		20



1 Introduction

1.1 Statement of Purpose

There have been several friendly fire incidents in recorded military history, accounting for an estimated 2% to 20% of all casualties in battle^[?]. Using attire to identify friend vs enemy is problematic in situations when both sides are clad in the same camouflage pattern, or are obscured by obstacles.

The purpose of this project is to create a system that quickly and accurately identifies friendly targets among military personnel on foot. Similar systems exist for aircraft, however not many exist for infantry.

The idea is to develop a two-way communication system so that when a soldier aims their weapon in the direction of a friendly target, they will receive notification through an LED that the target is, indeed, friendly and not an enemy. Throughout this document the infantry unit with the weapon will be referred to the "friendly interrogator" and the target will be referred to as the "friendly target".

This communication protocol can be

1.2 Objectives

1.2.1 Goals and Benefits

- Reduce number of friendly fire accidents during combat [?]
- Reduce number of misfires accidents during combat [?]
- Notify friendly personnel location of particular friendly target when aiming
- Other applications including but not limited to:
 - Paintball or Airsoft
 - Arcade Laser Tag

1.2.2 Functions and Features

- Laser diode on friendly interrogator to transmit unique I.D. of friendly interrogator.
- Photodiodes on friendly target to detect unique I.D. and verify it is a valid signal.
- R.F. Transmitter on friendly target to send acknowledgement back to interrogator.
- R.F. Receiver on friendly interrogator to verify that the target is friendly.
- LED on friendly interrogator to indicate to the operator the status of the target.



2 Design

2.1 Block Diagrams and Descriptions

2.1.1 System Overview

The following figure represents the system as a whole, including both the friendly interrogator unit and the friendly target unit. Both units will be expanded upon in further detail below.

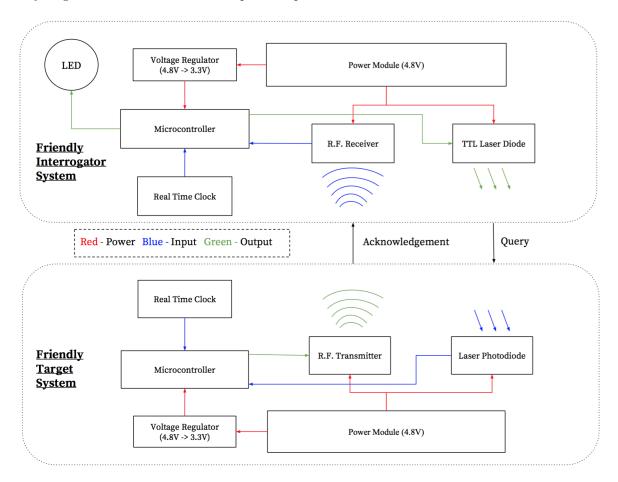


Figure 1: System Block Diagram

2.1.2 Friendly Interrogator Unit

The following diagram shows the friendly interrogator unit *only*. The interconnections in red represent power, interconnections in blue represent input to a block and interconnections in green represent output to a block. These inputs and outputs are described below under each block description.



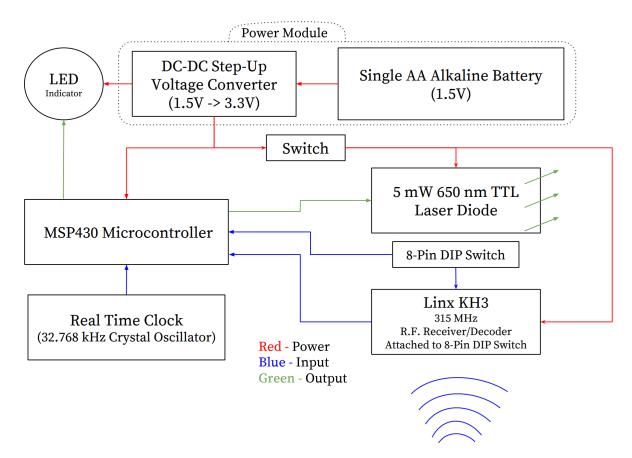


Figure 2: Block Diagram of Friendly Interrogator Unit

Power Module

Power-In, , N/A

Power-Out: MSP430 Microcontroller, 5mW Laser Transmitter, R.F. Receiver/Decoder, LED Indicator

Input(s): N/A
Output(s): N/A

The power module will consist of a single standard alkaline AA battery (no specific brand/part name is necessary) which will lead into a Skyworks AAT1217 DC-DC step-up voltage converter. This will step the voltage up to 3.3V with a maximum current output of 100 mA which is sufficient enough to power the MCU, laser transmitter, and the R.F. receiver. Please refer to Section 2.5 for these calculations regarding power delivery to this unit and resistor/capacitor/inductor part selection.

As noted on the block diagram, in between the power module and the R.F. receiver/laser transmitter, there is a switch to control the power given to these two modules. This switch exists for two reasons: (1) to decrease power consumption and (2) to limit the amount of time the laser transmitter is sending data. This design choice will be expanded upon in Section ___.

The circuit to operate the DC-DC step-up converter is shown in Figure ??.



The battery will be mounted to the PCB a standard AA through-hole PCB battery mount shown in Figure 3. However, this will be omitted from the circuit schematic for simplicity purposes. During the construction of the PCB the team will have to create the



Figure 3: PCB Battery Mount

MSP430 Microcontroller

Power-In: 3.3V (from Voltage Converter Output)

Power-Out: N/A

Input(s): R.F. Receiver/Decoder Data-Out, 8-Pin DIP Switch, Real Time Clock (32.768kHz Crystal)

Output(s): LED, 5mW 650nm Laser Diode

The team chose to work with an T.I. MSP430F2274 Microcontroller Unit ^[1] due to its compiler simplicity, its availability in the ECE445 Senior Design Labs (available inventory) and the number of GPIO Pins on board (compared to other options, this model had several I/O pins and was the least expensive). Compared to many other MCUs on the market, the MSP430 is relatively well documented and there exist several support forums on the internet to assist the team throughout the duration of the project.

The board requires a 3.3V power supply to both the DV_{cc} (pin 2) and AV_{cc} (pin 16) which is why the voltage regulator is necessary as stated in the previous section.

As stated above, the input the MSP430 MCU will be the R.F. receiver/decoder signal, the 8-pin DIP switch, and the real time clock.

The R.F. receiver/decoder signal will be the acknowledgment sent from the friendly target. These outputs from the receiver/decoder will be fed into pins 20 - 27 on the MCU. This cooresponds to 8 bits of data the MCU will be receiving from the friendly interrogator.

The 8-pin DIP switch, which is the unique I.D. of the friendly interrogator, will be fed into pins 31 -38 on the MCU.

The 5 mW laser will be fed into pin 17 of the MCU to control the modulation of the signal to send the unique I.D. to the friendly target.

This unique I.D. provided by the DIP switch will be used in conjunction with the output pin to the laser transmitter to create a "laser pulse" that sends the data of the I.D. to the friendly target. This will be explained in more detail in section BLAHFUCKINGBLAH.

Progr

The above descriptions can be summarized with Table 1 below. Each pin/label is listed with the description of the input or output. The red rows indicate that the pin is a power/ground line, the blue rows indicate



that the pin is an input to the MCU and the green rows indicate that the pin is an output from the MCU.

Pin#	Label	Description	
1	TEST/SBWTCK	No Connection	
2	DVCC	Digital Supply Voltage	
3	P2.5/R _{osc}	No Connection	
4 DVSS Digital		Digital Ground Reference	
5	XOUT/P2.7	32.768 kHz Crystal Oscillator (-)	
6	XIN/P2.6	32.768 kHz Crystal Oscillator (+)	
7	~RST/NMI/SBWTDIO	No Connection	
8	P2.0/ACLK/A0/OA010 LED Indicator		
9	2.1/TAINCLK/SMCLK/A1/OA00	No Connection	
10	P2.2/TA0/A2/OA0I1	No Connection	
11	P3.0/UCB0STE/UCA0CLK/A5 No Connection		
12 P3.1/UCBOSIMO/UCBOSDA No Connection		No Connection	
13	P3 2/I/CROSOMI/I/CROSCI No Connection		
14	P3.3/UCB0CLK/UCA0STE	No Connection	
15	AVSS	C Analog Supply Voltage	
16	AVCC		
17	P4.0/TB0		
18	P4 1/TR1 No Connection		
19	19 P4.2/TB2 No Connection		

Pin#	Label	Description	
38	P1.7/TA2/TDO/TDI	8-Pin DIP Switch - Output 7	
37 P1.6/TA1/TDI		8-Pin DIP Switch - Output 6	
36	P1.5/TA0/TMS	8-Pin DIP Switch - Output 5	
35 P1.4/SMCLK/TCK 8-Pin DIP Swit		8-Pin DIP Switch - Output 4	
34	P1.3/TA2	8-Pin DIP Switch - Output 3	
33	P1.2/TA1	8-Pin DIP Switch - Output 2	
32	P1.1/TA0	8-Pin DIP Switch - Output 1	
31	P1.0/TACLK/ADC10CLK	8-Pin DIP Switch - Output 0	
30 P2.4/TA2/A4/VREF+/VeREF+/OA110 No Connec		No Connection	
29 P2.3/TAI/A3/VREF-/VeREF-/OAIII/OAIO No Connection		No Connection	
28	P3.7/A7/OA112	R.F. Receiver/Decoder - Valid Transmission Line	
27	P3.6/A6/OA012	R.F. Receiver/Decoder - D0 Data Line	
26	P3.5/UCA0RXD/UCA0SOMI	R.F. Receiver/Decoder - D1 Data Line	
25	P3.4/UCA0TXD/UCA0SIMO	R.F. Receiver/Decoder - D2 Data Line	
24	P4.7/TBCLK	R.F. Receiver/Decoder - D3 Data Line	
23	P4.6/TBOUTH/A15/OA1I3	R.F. Receiver/Decoder - D4 Data Line	
22	P4.5/TB2/A14/OA0I3	14/OA013 R.F. Receiver/Decoder - D5 Data Line	
21	P4.4/TB1/A13/OA1O	R.F. Receiver/Decoder - D6 Data Line	
20	P4.3/TB0/A12/OA0O	44.3/TB0/A12/OA0O R.F. Receiver/Decoder - D7 Data Line	

Table 1: Pin Layout Table

Please refer to Section 2.3 to view in-depth discussion about the functionality of the MSP430F2274 Microcontroller Unit and how it will be used throughout this project.

Real Time Clock

Power-In: N/A
Power-Out: N/A
Input(s): N/A

Output(s): MSP430 Microcontroller

The real time clock is necessary for the verification of the acknowledgement signal sent by the R.F. transmitter on the friendly target unit. It will operate using a 32.768 kHz Crystal Oscillator (as recommended by T.I. $^{[2]}$) with an accuracy of +/- 20 PPM (Parts Per Million - deviates between 32.7673 kHz and 32.7687 kHz). It will be used in conjunction with the real time clock library provided by T.I. INSERT REFERENCE HERE.

Laser Diode

Power-In: 3.3V (from Voltage Converter Output)

Power-Out: N/A

Input(s): MSP430 Microcontroller Output(s): 5mW 650nm laser signal containing unique I.D. of interrogator

The team will use a 5 mW 650 nm TTL laser transmitter to transmit the unique I.D. (as specified by the 8-pin DIP switch) to the friendly target. This laser will operate on 3.3V at 25mA so a 1.3Ω resistor is necessary to drop the current being supplied to the diode down to this threshold.

Due to safety and ethical considerations, the requirements have changed for the divergence of the beam. The proposal stated a requirement of a 5-6 ft diameter beam at 50, 150, and 300 m (with optical adjustments allowed). This was assuming the team was using a 20mW laser diode which is now not the case (this design choice will be discussed in both Section 3.2 and Section 2.5 as appropriate). Instead the team will be using



a 5 mW laser which will produce a beam divergence of 2.5-2.75 feet at ____ feet.

Again, please refer to Section 3.2 and Section 2.5 to view an in-depth discussion about these design choices.

R.F. Receiver/Decoder

Power-In: 3.3V (from Voltage Converter Output)

Power-Out: N/A

Input(s): 8-Pin DIP Switch

Output(s): MSP430 Microcontroller

A Linx 315 MHz KH3 Series R.F. Receiver/Decoder will be used for this project along with a Linx 315-SP Splatch PCB Mounted Antenna. Some important values that were used in the selection process of this part are listed in Table 2

Parameter	Typical Value
Operating Voltage	3.3V
Supply Current	$5.9 \mathrm{mA}$
Receiver Frequency	$315~\mathrm{MHz}$
Receiver Sensitivity	-116 dB
R.F. Input Impedance	50Ω
Datarate	100 bps - 10,000 bps
Receiver Turn-On Time	$7.0 \mathrm{\ ms}$

Table 2: Linx 315 MHz KH3 R.F. Receiver

Important values to note are the R.F. input impedance, the receiver frequency, and the receiver sensitivity. The input impedance is stating it requires the entire R.F. receiver system to be matched at 50 Ω . This requires the trace on the PCB from the receiver to the antenna to also be at a 50 Ω impedance. The frequency and sensitivity affect the range of the receiver/transmitter pair and this calculation along with the PCB trace-width calculation can be found in Section 2.5.

The decoder provides very important functionality and simplicity to the system. There are a total of 10 address lines on the decoder that must match up to the cooresponding transmitting encoder. The lines do not output data through the data-out lines if the address lines do not match up. The team decided to make use of these lines and wire them up to a 8-pin DIP switch so that the operator can choose their unique interrogator I.D. Therefore only 8 out of the 10 address lines on the encoder will be used and the top two most significant bits will be grounded (lines A9 and A10).

As stated before this identification number will be fed into the MCU also and it will determine what the 5mW laser transmitter will send out to the friendly target. This process will be explained in Section 2.3.



2.1.3 Friendly Target Unit

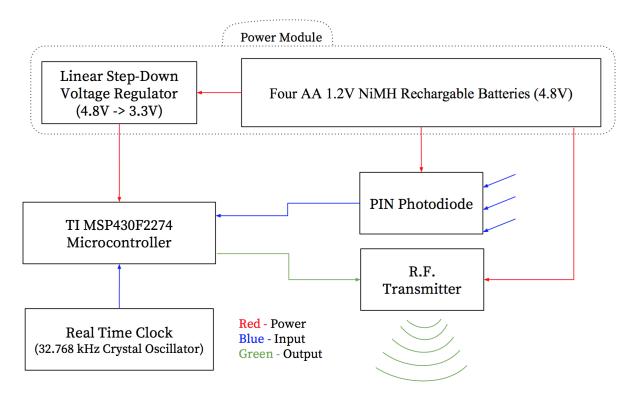


Figure 4: Block Diagram of Friendly Target System

Power Module

Power-In: N/A Power-Out: Input(s): Output(s):

The power module on board the Friendly Target Unit will be the same as the Friendly Interrogator Unit. The Please reference that section to get all details pertaining to the power module.

Microcontroller

Power-In:

Power-Out:

Input(s):

Output(s):

INDICATE WHICH PINS ARE ACTIVE AND NOT

Real Time Clock

Power-In:

Power-Out:

Input(s):

Output(s):



The Real Time Clock on board the Friendly Target Unit will be the same as the Friendly Interrogator Unit. Please reference that section to get all details pertaining to the Real Time Clock.

Laser Photodiode

Power-In:

Power-Out:

Input(s):

Output(s):

R.F. Transmitter

Power-In:

Power-Out:

Input(s):

Output(s):

A Linx 315 MHz LR Series R.F. Transmitter will be used for this project along with a Linx 315-SP Splatch PCB Mounted Antenna. This is an identical setup to the receiver end on the friendly interrogator unit as discussed before.

The

Parameter	Typical Value
Transmit Frequency	$315~\mathrm{MHz}$
Output Power	4 dB
Data Rate	10,000 bps
R.F. Output Impedance	50Ω
Transmitter Turn-On Time	$1.0 \; \mathrm{ms}$

Table 3: Notable Datasheet Values for Linx 315 MHz LR R.F. Transmitter

2.2 Circuit Schematics

2.2.1 Friendly Interrogator Unit

The circuit schematic is shown below for the Friendly Interrogator Subsystem. INSERT OVERALL CIRCUIT SCHEMATIC HERE



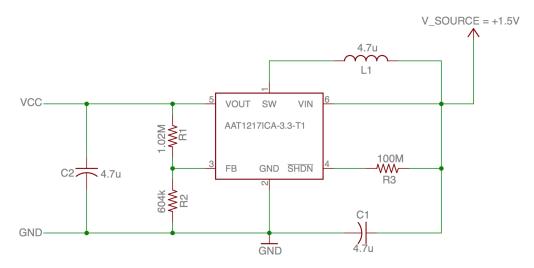


Figure 5: AAT1217 Circuit Schematic

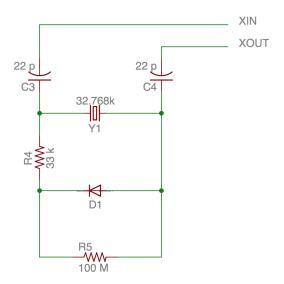


Figure 6: Crystal Oscillator Real Time Clock Circuit Schematic



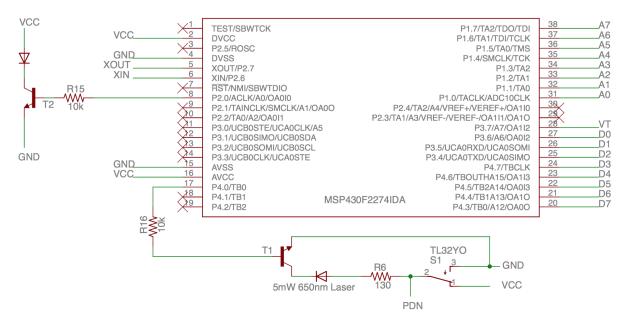


Figure 7: MCU and Laser Transmitter Circuit Schematic

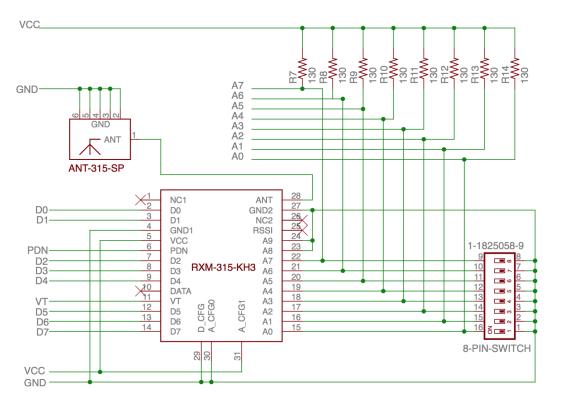


Figure 8: RF Receiver/Decoder and 8-Pin DIP Switch Schematic

2.2.2 Friendly Target Unit



2.3 Functionality

Do we need any setup procedures?

2.4 Software Flowcharts / Functionality

2.4.1 System Flow

This section is to explain the overview of how each part interfaces with another and the protocol used to transmit data from both the friendly interrogator unit to the friendly target unit. The below diagram is a flowchart representing the flow of events that occur to identify a target as friendly. Each individual label will be explained in extensive detail below.

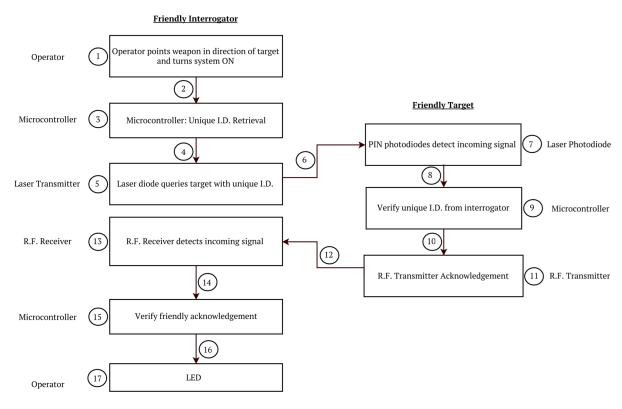


Figure 9: Flowchart for Functionality

The left side of this diagram are all events that occur within the friendly interrogator unit, and the right side represents all of the events that occur on the friendly target side. This flow diagram also assumes that both the interrogator operator and the friendly target operator have powered on their respective units.

2.4.2 Friendly Interrogator Software Flow

The software on the MCU on the friendly interrogator unit will follow a very simple flow. The MSP430F2274 contains 16 registers of which 4 are protected and 12 are general purpose registers:

• R0 - program counter



- R1 stack pointer
- R2 status register
- R3 constant generator
- R4 R15 general purpose registers

2.5 Numerical Analysis and Simulations/Plots

2.5.1 Calculations

Power Module (Friendly Interrogator Unit)

The following section is intended to backup the design choices made for the power module on the friendly interrogator first shown in section 2.1.2.

The team placed a strict requirement (shown in section \dots) regarding the operation time of the friendly interrogator unit (at 8 hours of operation time $\pm 5\%$ verify).

In order to select parts that satisfied this requirement, the active current consumption on the entire unit must first be calculated. The main power consumption modules on board the friendly interrogator unit are the MSP430F2274, the 5mW 635nm TTL laser transmitter, and the Linx KH3 R.F. receiver. These values were received from each of the respective datasheets. The following table displays the active current consumption of each unit.

Module	Active Current Consumption	Standby Current Consumption
MSP430	\sim 270 μ A	$0.1 - 0.7 \mu A$
Linx KH3 R.F. Receiver	5.9 mA	0 mA
5 mW Laser	25 mA (max)	0 mA

Table 4: Notable Datasheet Values for Linx 315 MHz LR R.F. Receiver

Because the R.F. receiver and the 5mW laser will only be powered when the operator designates, the standby current consumption of these units will be 0.

Therefore, with this information, the maximum possible active current consumption will be:

$$I_{Total} = 270\mu A + 25mA + 5.9mA + 0.7\mu A$$

Assuming the team uses a standard Alkaline AA 1.5V Battery, these typically produce anywhere from 1800mAh to 2500 mAh insert reference here. Therefore, the average of these two values will be used as the capacity of the battery: 2150 mAh. Since all of the components being used requires 3.3V, this battery must be fed into a voltage step-up converter as stated previously. The team is using the AAT1217 step-up converter this boosts the voltage up from 1.5V to 3.3V with a 75% efficiency insert reference here.

Using energy conservation laws, the equivalent capacity can be determined after stepping this voltage up from 1.5V to 3.3V. Since Energy = Power * time, we can use a ratio of the energy produced per hour of the standard alkaline battery to the output voltage of the converter. This calculation can be shown below:



$$Total Capacity = \frac{P_{\text{battery}}*time*V_{\text{battery}}}{V_{\text{converter-output}}}*Converter Efficiency$$

$$Total Capacity = \frac{2150mAh*1.5V}{3.3V}*75\% = 732.95mAh*0.75 = \textbf{14.95 hr active use}$$

This result shows that a single standard alkaline AA 1.5V disposable battery will be more than sufficient enough to satisfy the requirements of 8 hours of active use time.

Antenna-to-Receiver and Antenna-to-Transmitter PCB Impedance Matching

The input impedance of both the Linx R.F. receiver, transmitter and antenna are all 50 Ω . Therefore, in order to match this impedance on the line that goes from the receiver/transmitter chip to the antenna chip, the width must be calculated on the PCB trace.

Figure 10 shows all variables that affect the impedence of a PCB trace.

T = trace thickness (in mils) W = trace width (in mils) H = heigh of substrate (in mils) $\epsilon = \text{dielectric constant of material}$

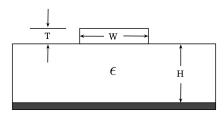


Figure 10: PCB Microstrip Impedence Variables

The equation to calculate the impedance is as follows:

$$Z = \frac{Z_0}{2\pi * \sqrt{2} * \sqrt{\epsilon + 1}} * ln \left(1 + 4 * \frac{H}{w_{eff}} * (X_1 + X_2) \right)$$

where

$$W_{eff} = W + \left(\frac{T}{\pi}\right) * ln \left\{ \frac{4*e}{\sqrt{\left(\frac{T}{H}\right)^2 + \left(\frac{T}{W*\pi + 1.1*T*\pi}\right)^2}} \right\}$$
$$X_1 = \frac{4*(14*\epsilon + 8)}{11*\epsilon} * \left(\frac{H}{W_{eff}}\right)$$
$$X_2 = \sqrt{16* \left(\frac{H}{W_{eff}}\right)^2 * \left(\frac{14*\epsilon + 8}{11*\epsilon}\right)^2 * \left(\frac{\epsilon + 1}{2*\epsilon}\right) * \pi^2}$$

The ECE parts shop uses 1 oz copper trace and FR4 board material as its substrate insert reference. Assuming these properties have not changed at the time of this design review, then the following values can be used for T, H, Z, Z_0 and ϵ :



$$Z_0=$$
 impedence of free space $\approx 120~\pi\Omega$
$$T=1.4 {\rm mils}$$

$$H=1.6 {\rm mm}$$

$$\epsilon=1.4$$

$$Z=50\Omega$$

The result after plugging in each respective value and solving for W, is that the PCB trace must be **3.23** mm wide going from each R.F. module to the antenna.

R.F. Transmitter/Receiver Range

The range of the R.F. transmitter and receiver is required to reach a distance of 300 meters. The range in kilometers is a function of the following variables:

 $P_T = \text{Transmitter Power (dBm)}$ $A_g = \text{Total Antenna Gain (dB)}$ $C_l = \text{Connection Loss (dB)}$ $G_{tot} = \text{Total Gain (dB)}$ R = Receiver Sensitivity (dBm) L = Transmission Path Loss (dB) $f_{MHz} = \text{Frequency in MHz}$

Transmission Path Loss is the sum of all the antenna R.F. gains and deduction of all possible losses. Assuming a perfect system on the ground without any interference the following equation can be used to calculate the path loss in a transmission:

$$L = P_T + (A_g - C_l)$$

This equation can be used in conjunction with the following equation to calculate the total range in kilometers:

$$d_{TX->RX} = 10^{\left(\frac{L-32.45-20*log(f_{MHz})}{20}\right)}$$

The following values were used in this range calculation:

$$P_T = +4 \mathrm{dBm}$$
 $A_g = 2.15 \; \mathrm{dBi}$ (quarter-wave monopole) $C_l = 0 \; \mathrm{dB}$ $G_{tot} = 2.15 \mathrm{dB}$ $R = -116 \; \mathrm{dBm}$ $L = 120.15$

Plugging in these values to the equation stated before, the team received a range of **77.03 km** which well surpasses the requirements of 300 m.



Power Module (Friendly Target Unit)

Laser Diode

With some tolerance, the PIN photodiode used in the friendly target system can register an irradiance of 9 $\frac{W}{m^2}$. The laser required to achieve this irradiance is a function of the laser power and the radius of the beam. With relatively short distances of 0-300 m, atmospheric deflection of light is negligible. f_{MHz} = Frequency in MHz

Using trigonometry, the power as a function of radius is given by $P = \pi r^2 E_{req}$, where r is the radius (in meters) and E_{req} is the required irradiance of 9 $\frac{W}{m^2}$.

For a diameter equal to the one stated in the proposal ($\approx 1.6764m$), a $\pi (0.8382)^2(9) \approx 20mW$ laser is needed. A 20mW laser is a Class 3B laser, and is considered dangerous. For the scope of this senior design project, a 5mW laser will be used instead.

The radius achieved using a 5mW laser is given by $\sqrt{\frac{P}{E_{req}\pi}} = 0.420522m$. This is approximately a 2.75ft diameter beam, which is still the size of a person's chest.

2.5.2 Simulations/Plots

INSERT PLOTS/ANY SORT OF ANALYSIS HERE

3 Requirements and Verification

UPDATE THIS TABLE-maybe reference an appendix in the back?

Block/Subsystem	Module	Requirement	Verification
	Laser Diode	Must be able to achieve 5 mW of power at source with a wavelength in the visible light spectrum from 620–750 nm (red).	Verify with multimeter that the laser is producing 5 mW at source. Verify the laser is in the visible light spectrum from 620-750nm using a
		Light from the beam must span a range of 10-15 inches at the following distances, with optical adjustments allowed: - Short Range (50 m) - Medium Range (150 m) - Long Range (300 m)	Field Test - Verify laser transmission at distances for three ranges.
	Power Module	Must maintain a constant DC power source of $4.8V \pm 5\%$.	Attach power module to digital multimeter in parallel and measure output voltage with and without load components attached.
Friendly Interrogator System: Laser Transmitter		Must be able to supply 4.8V for a period of 8 hours \pm 5%.	Attach power module to digital multimeter in parallel and measure output voltage over a period of time.
		Must be able to output a constant voltage of 3.3V with \pm 0.3V deviation (i.e. 3.27V < Vout < 3.33V), with a current supply of max 75mA.	Attach power module to digital multimeter in parallel and measure output voltage with and without load components attached.
	Real Time Clock (RTC)	Must oscillate at a frequency of 32.768 kHz with a precision of \pm 20 PPM.	Attach oscilloscope to outputs of crystal oscillator circuit and measure frequency
	Microcontroller (MCU)	Ability to control laser transmitter to send digital data at a frequency of at least 30 kHz.	Verify using oscilloscope connected to output generated by MCU and measuring period time in μs .
		Must maintain its own internal clock to a precision of \pm 10 minutes \pm 10%.	Sample packets sent to microcontroller and verify time with that of a local known source.

Figure 11: Requirements/Verification for Laser Transmitter System



3.1 Tolerance Analysis

NEED TO INCLUDE IN DEPTH ANALYSIS-

Tolerance analysis is part of the DESIGN process. The tolerance analysis is not an experiment to see what the limits of your project are after it has been designed and built. The tolerance analysis is an exercise in working backwards from what your goal is, and then figuring out how precise a specific hardware component must be. "We will stress the device until it no longer works as intended and look at the results" is not a tolerance analysis. "Given that we have a goal of X, The accuracy of component Y must be Z to achieve X properly" is a tolerance analysis. It should involve math and design equations. For example, in amplifier design there is usually a bias circuit that includes a resistor network. Resistor values in real life are not exact and have an advertised tolerance (10%, 5%, 1%). Find how accurate your resistors must be to meet your gain or bandwidth requirements in the worst case scenario. If it is lower than 10%, you have just concluded that your design will require parts with a tighter tolerance.

3.2 Safety

Laser Diode

As stated previously, the proposal requirements would have required a 20mW IR laser. However, in the State of Illinois, a 20mW laser is considered a Class 3B laser and must be registered with the Division of Nuclear Safety in the Illinois Emergency Management Agency. This would have required the team to file the correct paperwork and pay a registration fee of \$50. This paperwork would have likely caused delays in receiving parts and construction of this project. A 20~mW laser would have also needed much more pre-caution and safety mitigations than a much less powerful laser.

For the reasons stated above, the team will instead use a 5mW visible red laser. 5mW visible lasers have a low chance of injuring the eye, as the blinking reflex will save a victim from permanent damage; as opposed to IR lasers which can go unnoticed for several seconds.

The following is a calculation for the nominal ocular hazard distance (NOHD) of our laser, as defined by the ANSI Standard [3].

The maximum permissible exposure (MPE), as defined by the ANSI Standard [3] is the highest power or energy density of a light source that is considered safe, i.e. that has a negligible probability for creating damage. This MPE for a pulsing laser is calculated as the minimum of the following three rules:

- 1. Any single pulse in the train must not exceed the MPE for the pulse exposure time.
- 2. The exposure from any group of pulses delivered in time T must not exceed the MPE for time T, where T is 0.25 seconds (from the blinking reflex), for a visible laser.
- 3. For thermal injury, the exposure for any single pulse within a group of pulses must not exceed the single-pulse MPE multiplied by a multiple-pulse correction factor

The laser will pulse at a rate of 40 kHz. Assuming at most a 50% duty cycle, each pulse will be of max length $1.25*10^{-5}s$. The divergence of the beam is smallest for the longest range; a lower divergence is more restrictive in terms of safety, so this calculation uses 300m. The divergence of the beam for 300m is 2.79



mrad and the beam waist is approximately 4mm.

Following the ANSI Standard [3], the Rule 1 calculation is

$$5 * 10^{-3} * (\frac{2.79}{1.5}) = 0.0093 \frac{J}{m^2}$$

The Rule 2 calculation is

$$\frac{18(.25^{0.75})(\frac{2.79}{1.5})}{.25*40000} = 0.0011837 \frac{J}{m^2}$$

The Rule 3 calculation is

$$(.25 * 40000)^{0.25} * 5 * 10^{-3} * (\frac{2.79}{1.5}) = 0.093 \frac{J}{m^2}$$

The most restrictive of all the rules is Rule 2, which gives us an MPE of $0.0011837 \frac{J}{m^2}$.

At 5mW with a pulse width of $1.25*10^{-5}$, the power of the laser is $6.25*10^{-8}J$.

The NOHD is defined as

$$\frac{\sqrt{\frac{4*P}{\pi*MPE}} - 2w}{\theta}$$

Where P is the power of the beam $(6.25 * 10^{-8} J)$ and w is the waist of the beam (1mm). This gives an NOHD of

$$\frac{\sqrt{\frac{4*6.25*10^{-8}}{\pi*0.0011837}} - 2(0.004)}{0.00279} = 0.0713m$$

The team will avoid eye damage by not working with their eyes inside of 8 cm from the laser. If it is necessary to get this close to the laser, the team will wear eye protection or simply power off the laser.

3.3 Ethical Issues

This project has several ethical issues that can be addressed by the IEEE Code of Conduct. Specifically, numbers 1, 2, 3, 5, 6, 7, and 9 are the most important items that pertain to the Infantry I.F.F. System the team is building this semester.

- 1. to accept responsibility in making decisions consistent with the safety, health, and welfare of the public, and to disclose promptly factors that might endanger the public or the environment;
- 2. to avoid real or perceived conflicts of interest whenever possible, and to disclose them to affected parties when they do exist;
- 3. to be honest and realistic in stating claims or estimates based on available data;
- 5. to improve the understanding of technology; its appropriate application, and potential consequences;
- 6. to maintain and improve our technical competence and to undertake technological tasks for others only



if qualified by training or experience, or after full disclosure of pertinent limitations;

- 7. to seek, accept, and offer honest criticism of technical work, to acknowledge and correct errors, and to credit properly the contributions of others;
- 9. to avoid injuring others, their property, reputation, or employment by false or malicious action;



4 Cost and Schedule

4.1 Cost Analysis

The labor cost was calculated as follows:

Labor Cost = Worker Salary (\$/hour) x 2.5 x Time (Hours) Invested In Project

COMPILE PARTS LIST, SUM UP TOTAL, ADD TO LABOR COSTS - SAME AS PROPOSAL

4.2 Schedule

EDIT SCHEDULE CREATED IN PROPOSAL



References

- [1] "Mixed Signal Microcontroller MSP430F22x4," Web, Texas Instruments, accessed February 2016. [Online]. Available: http://www.ti.com/lit/ds/symlink/msp430f2274.pdf
- [2] "Using the Real-Time Clock Library," Web, Texas Instruments, accessed February 2016. [Online]. Available: http://www.ti.com/lit/an/slaa076a/slaa076a.pdf
- [3] "American National Standard for Safe Use of Lasers," ANSI Z136.1-2000.